

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE



**Field device integration (FDI) –  
Part 6: Technology Mapping**

**Intégration des appareils de terrain (FDI) –  
Partie 6: Mapping de technologies**



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## FIELD DEVICE INTEGRATION (FDI) –

## Part 6: Technology Mapping

## FOREWORD

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International Standard IEC 62769-6 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This second edition cancels and replaces the first edition published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) redesign of the security concept for UIP execution.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
65E/763/FDIS	65E/773/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

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## INTRODUCTION

The IEC 62769 series has the general title *Field Device Integration (FDI)* and the following parts:

- Part 1: Overview
- Part 2: FDI Client
- Part 3: FDI Server
- Part 4: FDI Packages
- Part 5: FDI Information Model
- Part 6: FDI Technology Mapping
- Part 7: FDI Communication Devices
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- Part 101-1: Profiles – Foundation Fieldbus H1
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